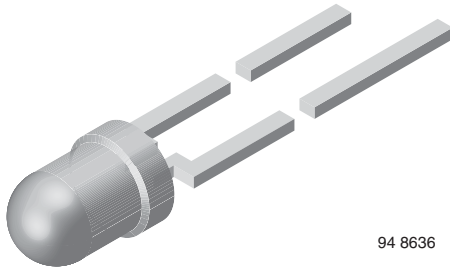


High Speed Infrared Emitting Diode, 940 nm, Surface Emitter Technology



94 8636

DESCRIPTION

As part of the SurfLight™ portfolio, the VSLY3943 is a high speed infrared emitting diode based on surface emitter technology, molded in a blue-gray plastic package.

FEATURES

- Package type: leaded
- Package form: T-1, clear epoxy
- Dimensions: Ø 3 mm
- Peak wavelength: $\lambda_p = 940$ nm
- High speed
- High radiant power
- High radiant intensity
- Angle of half intensity: $\phi = \pm 17^\circ$
- Low forward voltage
- Good spectral matching to Si photodetectors
- Material categorization: for definitions of compliance please see www.vishay.com/doc?99912



APPLICATIONS

- Infrared remote control units
- Free air transmission systems
- Infrared source for optical counters and card readers

PRODUCT SUMMARY

| COMPONENT | I_e (mW/sr) | ϕ (deg) | λ_p (nm) | t_r (ns) |
|-----------|---------------|--------------|------------------|------------|
| VSLY3943 | 70 | ± 17 | 940 | 5 |

Note

- Test conditions see table “Basic Characteristics”

ORDERING INFORMATION

| ORDERING CODE | PACKAGING | REMARKS | PACKAGE FORM |
|---------------|-----------|-------------------------------|--------------|
| VSLY3943 | Bulk | MOQ: 5000 pcs, 5000 pcs/bulk | T-1 |
| VSLY3943-MSZ | Ammopack | MOQ: 10 000 pcs, 2000 pcs/box | T-1 |

Note

- MOQ: minimum order quantity

ABSOLUTE MAXIMUM RATINGS ($T_{amb} = 25$ °C, unless otherwise specified)

| PARAMETER | TEST CONDITION | SYMBOL | VALUE | UNIT |
|--|--|------------|-------------|------|
| Reverse voltage | | V_R | 5 | V |
| Forward current | | I_F | 70 | mA |
| Peak forward current | $t_p/T = 0.1, t_p = 100$ μ s | I_{FM} | 140 | mA |
| Surge forward current | $t_p = 100$ μ s | I_{FSM} | 500 | mA |
| Power dissipation | | P_V | 160 | mW |
| Junction temperature | | T_j | 100 | °C |
| Operating temperature range | | T_{amb} | -40 to +85 | °C |
| Storage temperature range | | T_{stg} | -40 to +100 | °C |
| Soldering temperature | $t \leq 5$ s, 2 mm from case | T_{sd} | 260 | °C |
| Thermal resistance junction-to-ambient | J-STD-051, leads 7 mm, soldered on PCB | R_{thJA} | 300 | K/W |

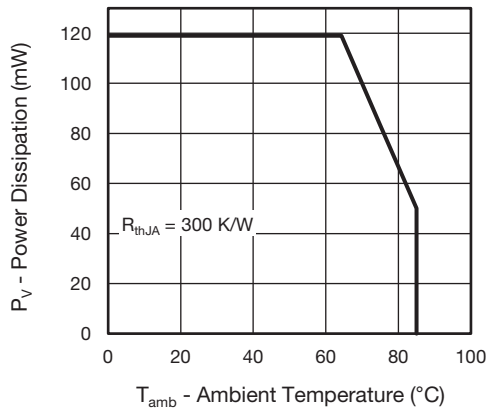


Fig. 1 - Power Dissipation Limit vs. Ambient Temperature

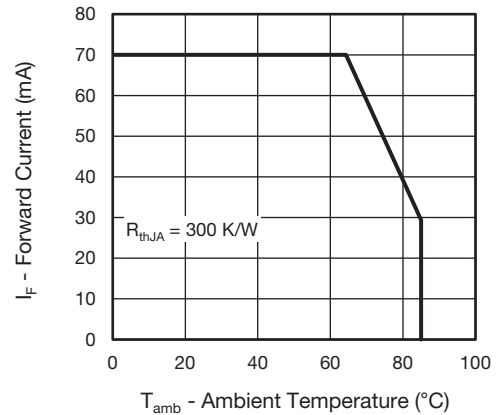


Fig. 2 - Forward Current Limit vs. Ambient Temperature

| BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified) | | | | | | |
|---|---|------------------|------------------------------------|----------|------|---------------|
| PARAMETER | TEST CONDITION | SYMBOL | MIN. | TYP. | MAX. | UNIT |
| Forward voltage | $I_F = 70\text{ mA}$, $t_p = 20\text{ ms}$ | V_F | - | 1.5 | 1.7 | V |
| | $I_F = 500\text{ mA}$, $t_p = 100\text{ }\mu\text{s}$ | V_F | - | 2.6 | - | V |
| Temperature coefficient of V_F | $I_F = 50\text{ mA}$ | TK_{V_F} | - | -0.7 | - | mV/K |
| Reverse current | $V_R = 5\text{ V}$ | I_R | Not designed for reverse operation | | | μA |
| Junction capacitance | $V_R = 0\text{ V}$, $f = 1\text{ MHz}$, $E = 0\text{ mW/cm}^2$ | C_J | - | 30 | - | pF |
| Radiant intensity | $I_F = 70\text{ mA}$, $t_p = 20\text{ ms}$ | I_e | 32 | 70 | 120 | mW/sr |
| | $I_F = 500\text{ mA}$, $t_p = 100\text{ }\mu\text{s}$ | I_e | - | 650 | - | mW/sr |
| Radiant power | $I_F = 70\text{ mA}$, $t_p = 20\text{ ms}$ | ϕ_e | - | 40 | - | mW |
| Temperature coefficient of radiant power | $I_F = 50\text{ mA}$ | TK_{ϕ_e} | - | -0.2 | - | %/K |
| Angle of half intensity | | ϕ | - | ± 17 | - | deg |
| Peak wavelength | $I_F = 50\text{ mA}$ | λ_p | - | 940 | - | nm |
| Spectral bandwidth | $I_F = 70\text{ mA}$ | $\Delta\lambda$ | - | 55 | - | nm |
| Temperature coefficient of I_p | $I_F = 70\text{ mA}$ | TK_{λ_p} | - | 0.28 | - | nm |
| Rise time | $I_F = 70\text{ mA}$, 10 % to 90 % | t_r | - | 5 | - | ns |
| Fall time | $I_F = 70\text{ mA}$, 10 % to 90 % | t_f | - | 6 | - | ns |

BASIC CHARACTERISTICS ($T_{amb} = 25\text{ }^{\circ}\text{C}$, unless otherwise specified)

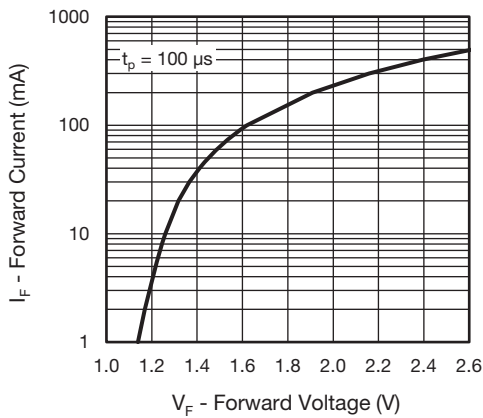


Fig. 3 - Forward Current vs. Forward Voltage

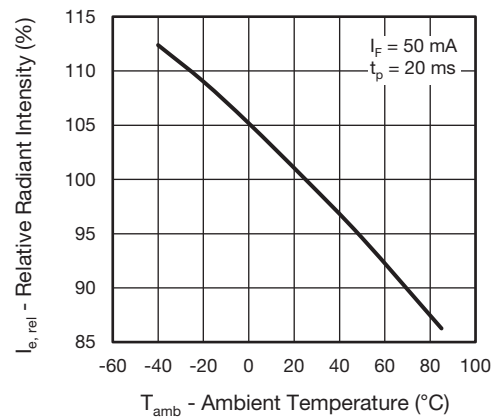


Fig. 6 - Relative Radiant Intensity vs. Ambient Temperature

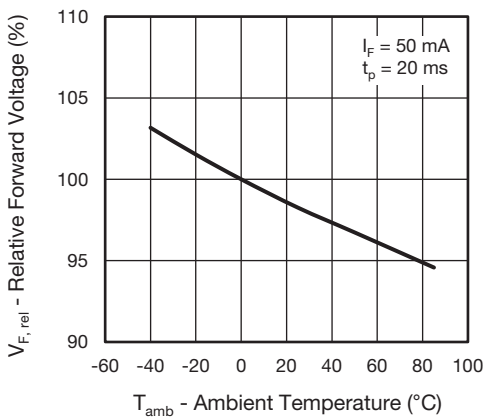


Fig. 4 - Relative Forward Voltage vs. Ambient Temperature

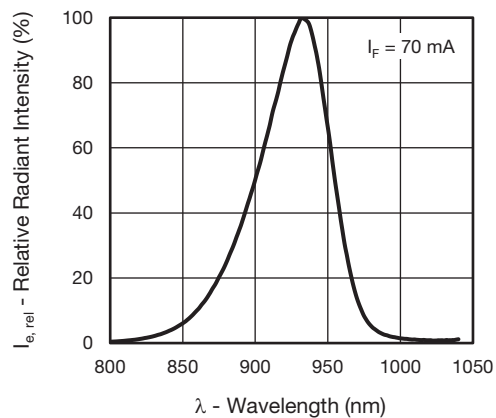


Fig. 7 - Relative Radiant Intensity vs. Wavelength

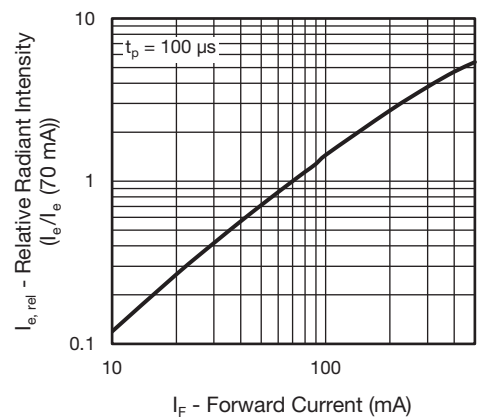


Fig. 5 - Relative Radiant Intensity vs. Forward Current

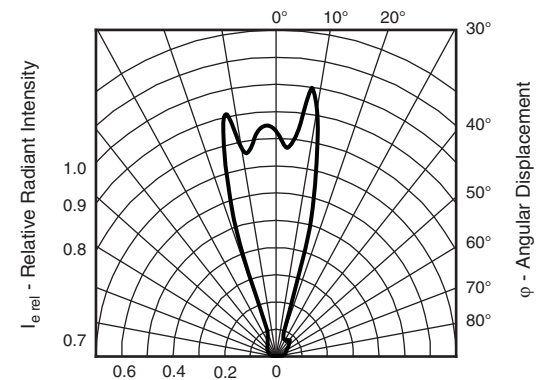
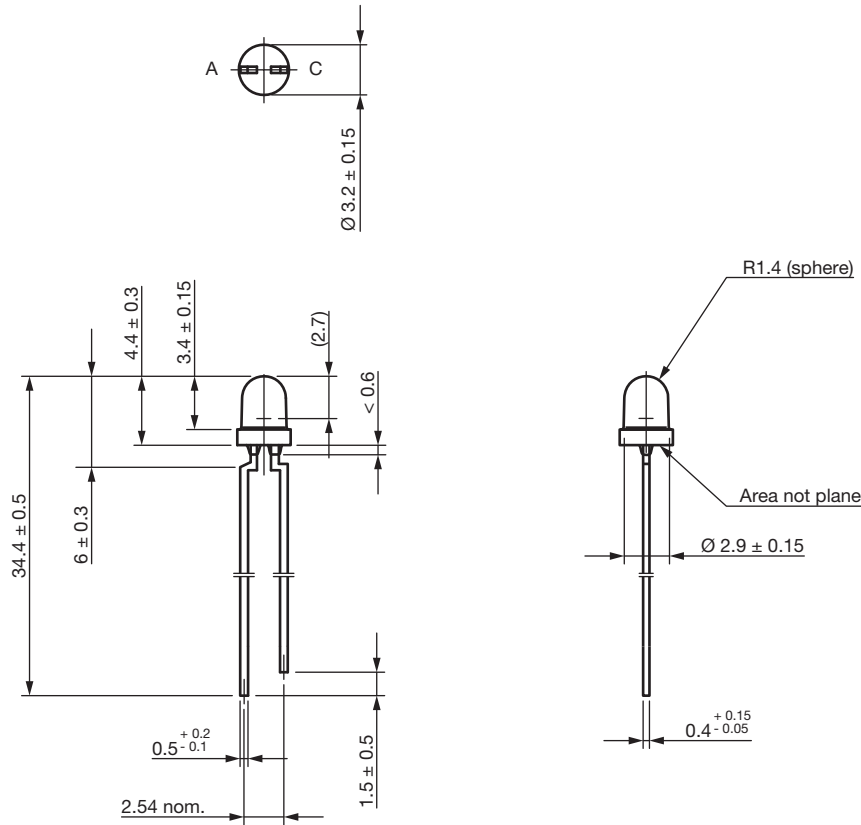
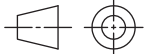


Fig. 8 - Relative Radiant Intensity vs. Angular Displacement



PACKAGE DIMENSIONS in millimeters




technical drawings
according to DIN
specifications

Drawing-No.: 6.541-5118.01-4
Issue: 1; 13.12.17



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